

# SOT1576-1

HQFN32, plastic, thermally enhanced quad; flat non-leaded package; 32 terminals; 0.65 mm pitch; 9 mm x 9 mm x 2.5 mm body

5 April 2017

Package information

### 1. Package summary

Terminal position code	Q (quad)
Package type descriptive code	HQFN32
Package type industry code	HQFN32
Package style descriptive code	HQFN (thermal enhanced quad flatpack; no leads)
Package body material type	P (plastic)
Mounting method type	S (surface mount)
Issue date	22-3-2017
Manufacturer package code	98ASA10842D

#### Table 1. Package summary

Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	-	-	9	-	mm
E	package width	-	-	9	-	mm
А	seated height	-	-	2.5	-	mm
е	nominal pitch	-	-	0.65	-	mm
n <sub>2</sub>	actual quantity of termination	-	-	32	-	

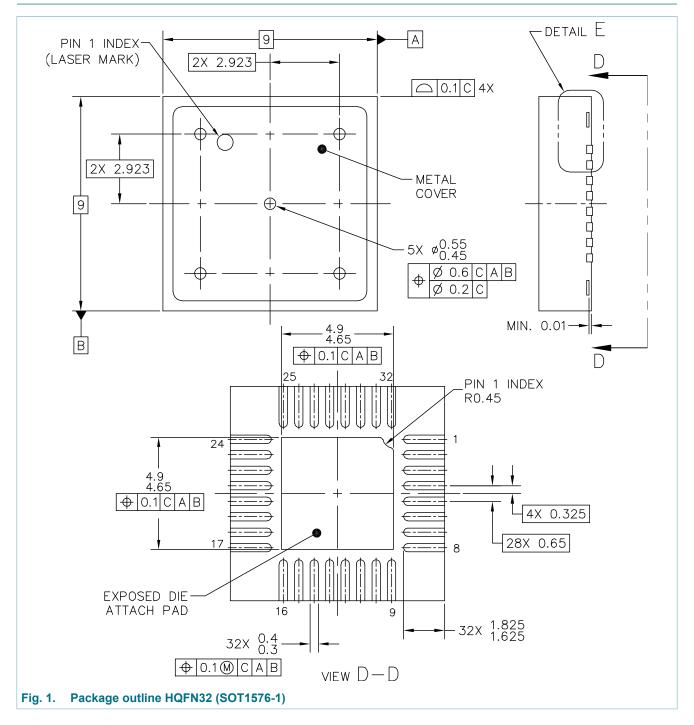


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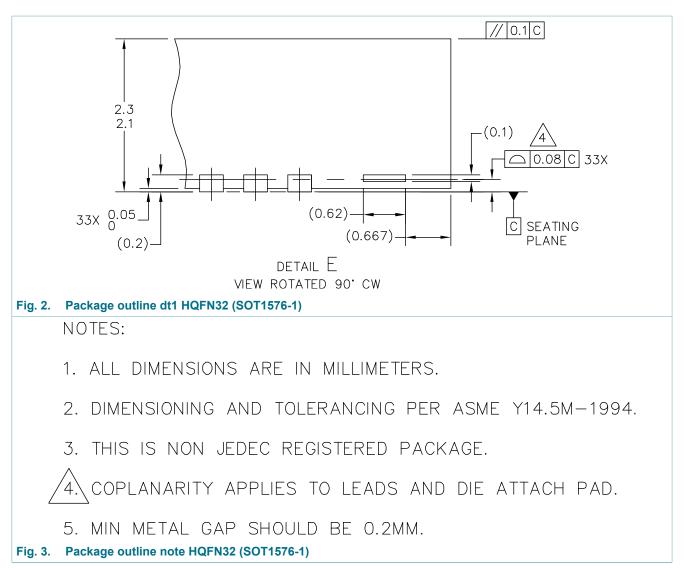
### 2. Package outline



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### 3. Legal information

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